

# Operation and Characterization from Electric Cool Ge Detectors at KSNL



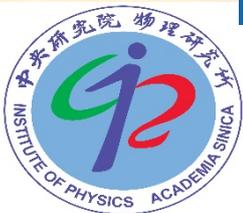
PIRE  
GEMADARC

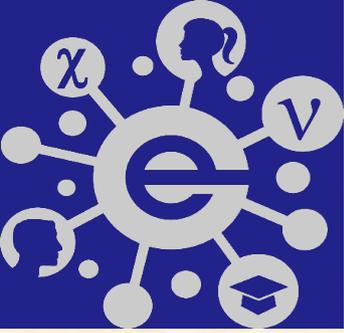
**Henry T. Wong** (*with Vivek Sharma*)

**Institute of Physics, Academia Sinica, Taiwan**



3rd PIRE-GEMADARC Collaboration Meeting (Knoxville, TN) and Ge Technology Workshop





## Outline of Talk

- Overview Electro-cooled Ge Detectors.
- Operation & Problems
- Performance: Threshold and background.
- Sensitivity for Low energy physics
- Future Prospects



# Design of ECGe

**Top View**



**Cooler**

**Cold finger**

**Detector Capsule**

**Side View**



**Air Out**

**Air In**

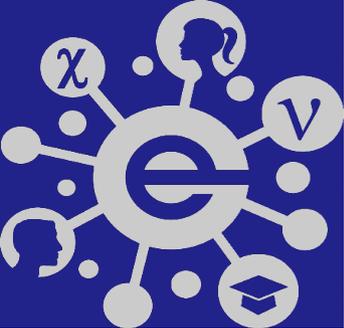
**Pre-Amp**

**Controller**

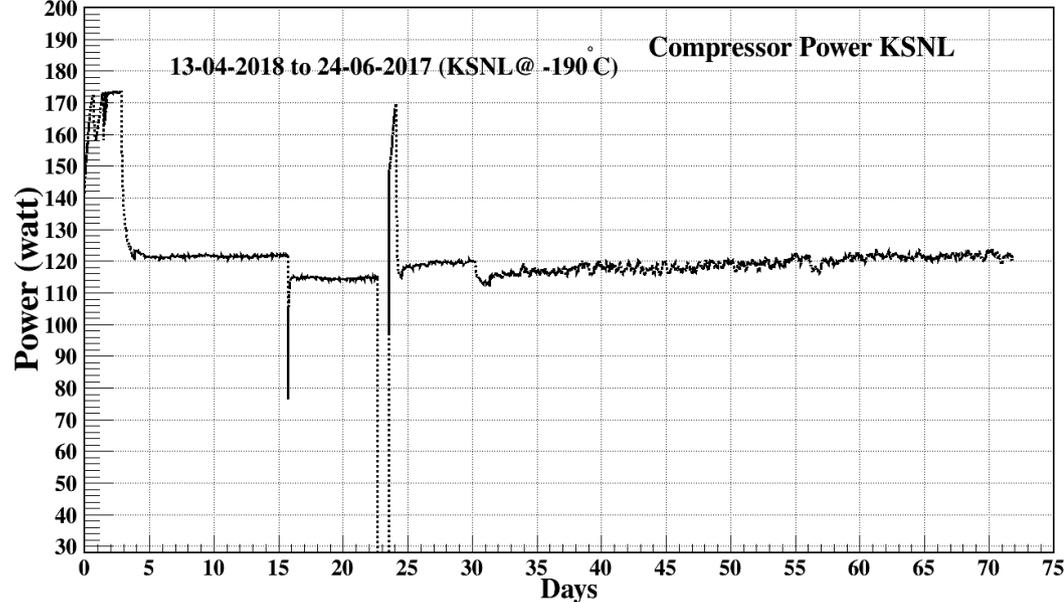
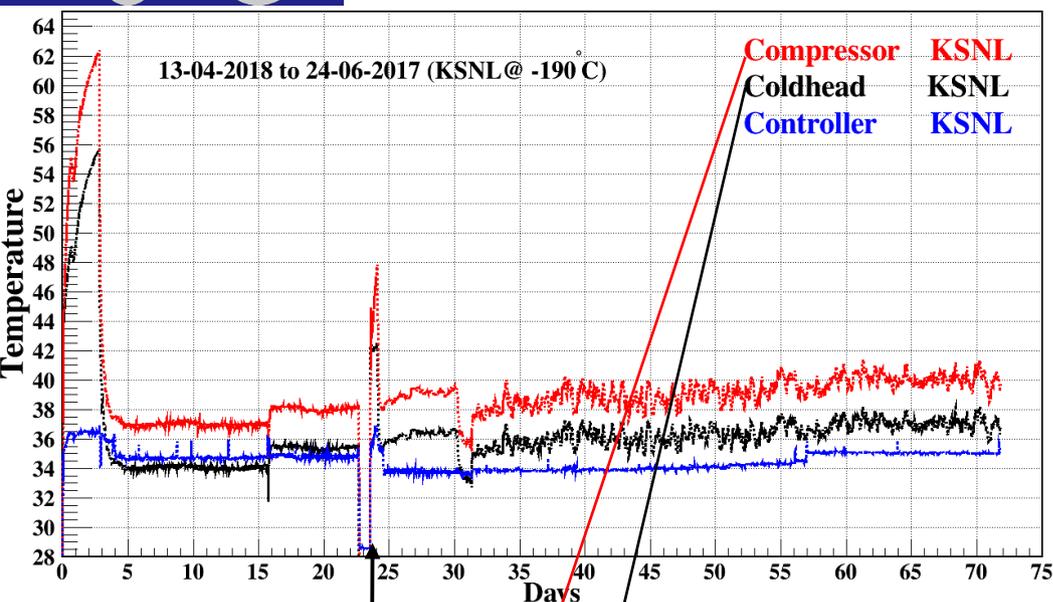
**Front Panel LEDs**



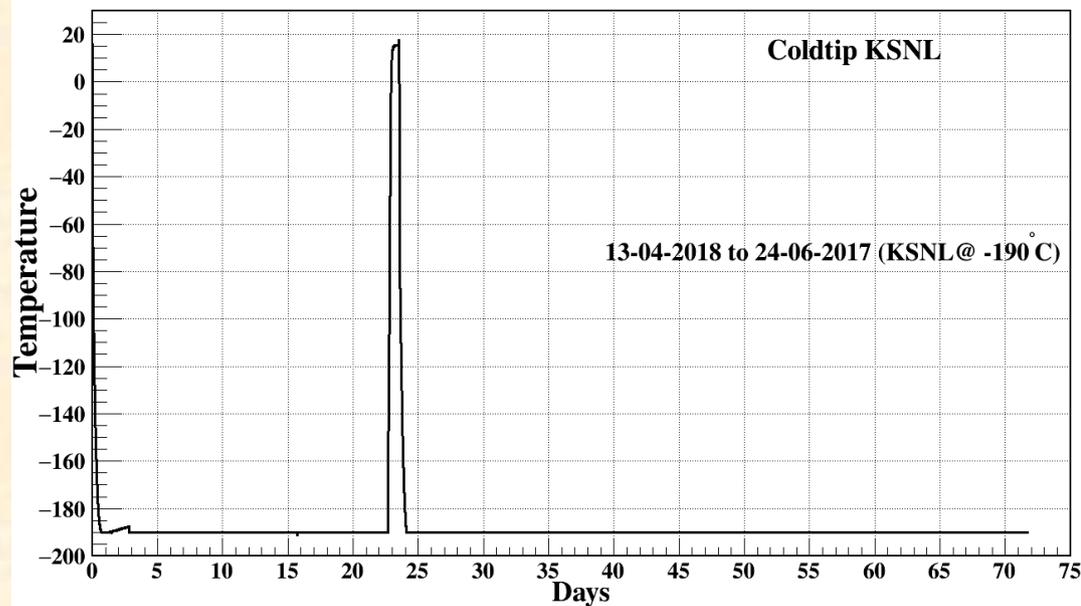
**Front Panel Display**

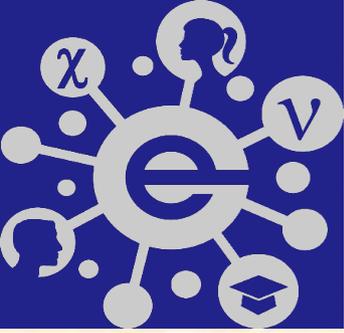


# Temperature and Power Profile



Thermal Recycle



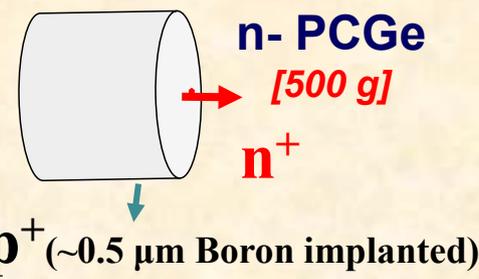
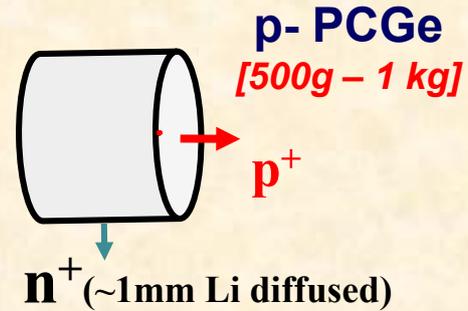
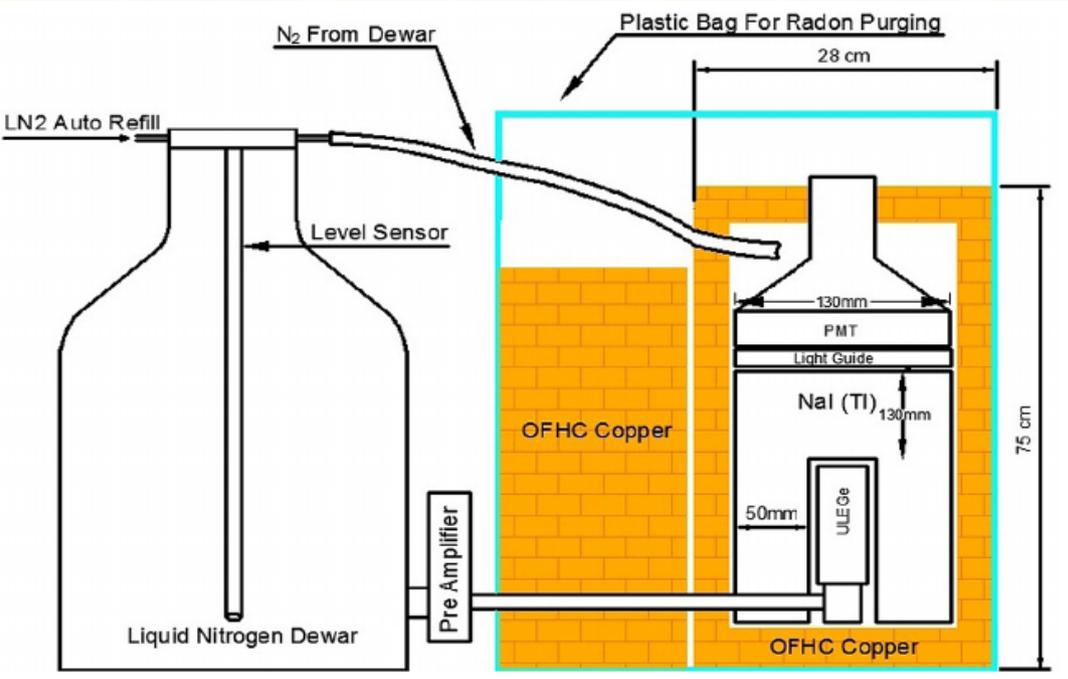


## Advantage of Electro-cool Ge detectors

- Customize Coldtip temperature for best frontend performance**
- Cooling with synchronized negative feedback pumping.**
- Less microphonic noise.**
- Compact (Portable) Design.**
- New JFET and ASIC FE-electronics near point contact.**



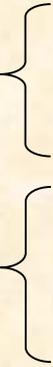
# Pulsar FWHM and Threshold



Generation	Mass (g)	Pulsar FWHM (eV <sub>ee</sub> )	Threshold (eV <sub>ee</sub> )
<b>G1</b>	500	130	500
<b>G2</b>	900	100	300
<b>G3</b>	900	70	200
<b>G3+</b>	1430	~60	~160

Liquid Nitrogen

Electro-cool





## Operation Problems (Difficulties)

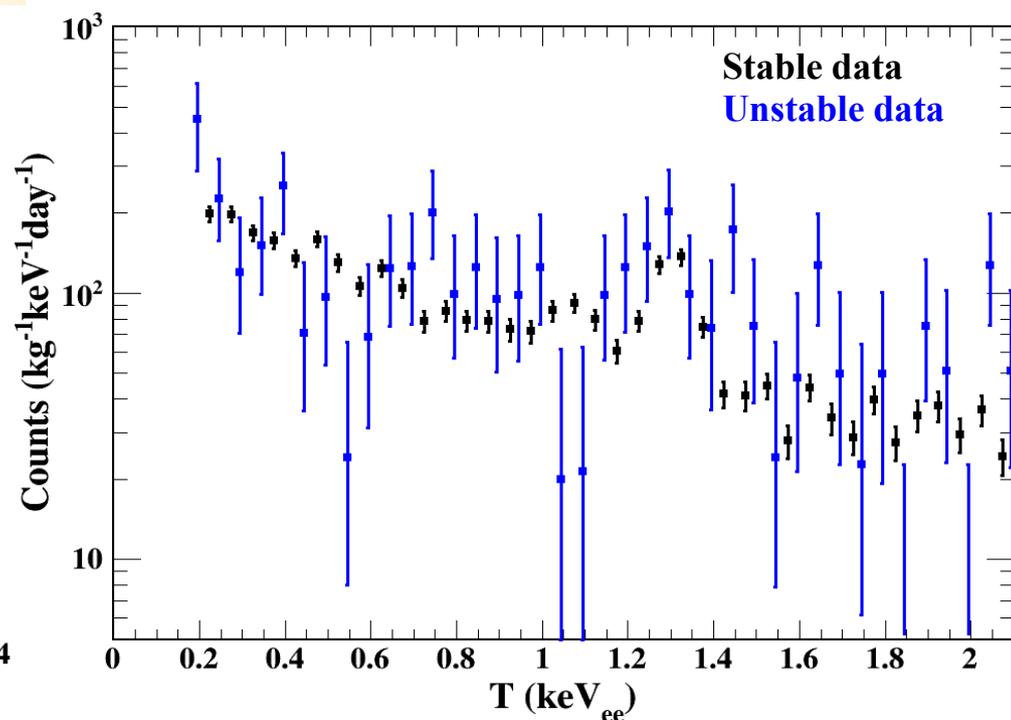
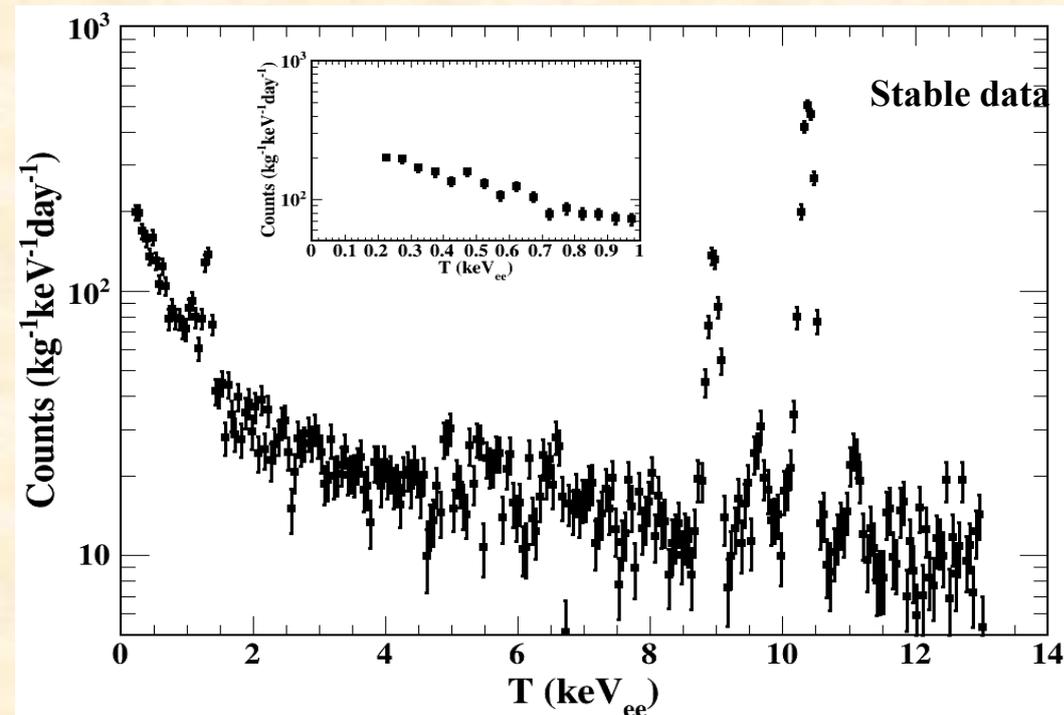
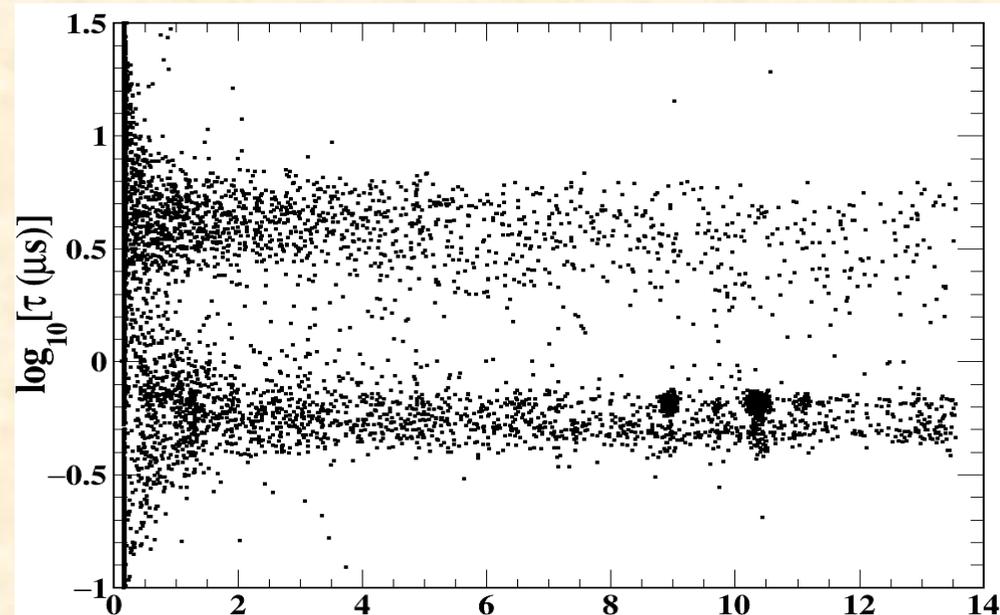
- ☑ Electro-cooler not powerful enough to cool down after some months -- due to outgassing of internal components.  
*Solution:* Necessary to do regular pump down by an external pump to remove residual air.
- ☑ Most performing front-end electronics have:
  - higher background (not yet low-background compatible)
  - High failure rates
- ☑ Repairs & Upgrades take long time than “regular” devices, indicating learning curve from company as well .....



# G3+ Generation Detector ..

## Germanium detector at -185 C

- Threshold secured 200 eV
- Pulsar FWHM 70 eV
- Clean Surface Bulk band





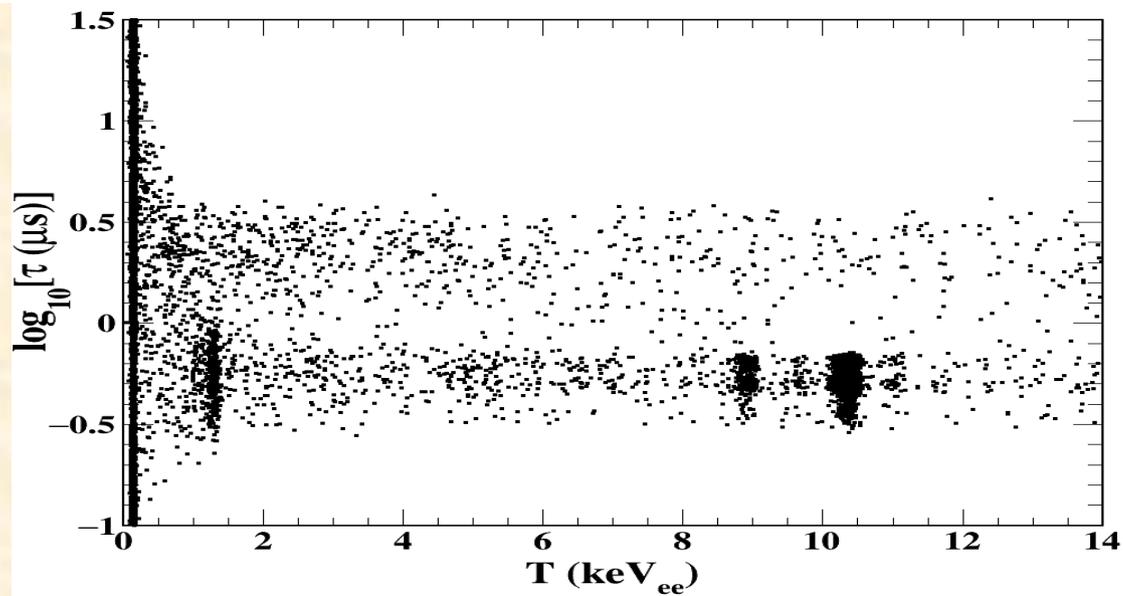
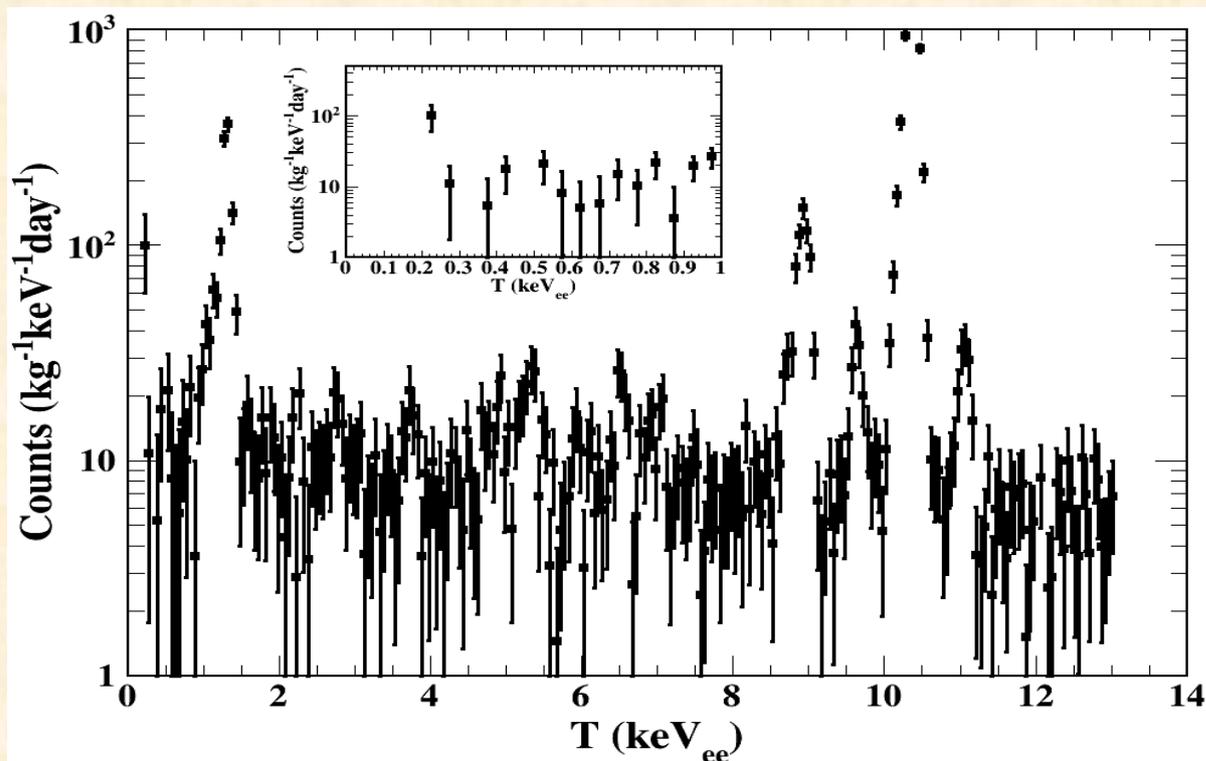
# G3 Generation Detector

Data collected with G3 detector:

• 30 kgd (-190 C)

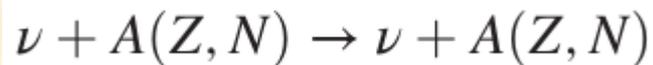
Encountered problems:

- 200 eV threshold.
- Pulsar FWHM 70 eV.
- Controlled background.

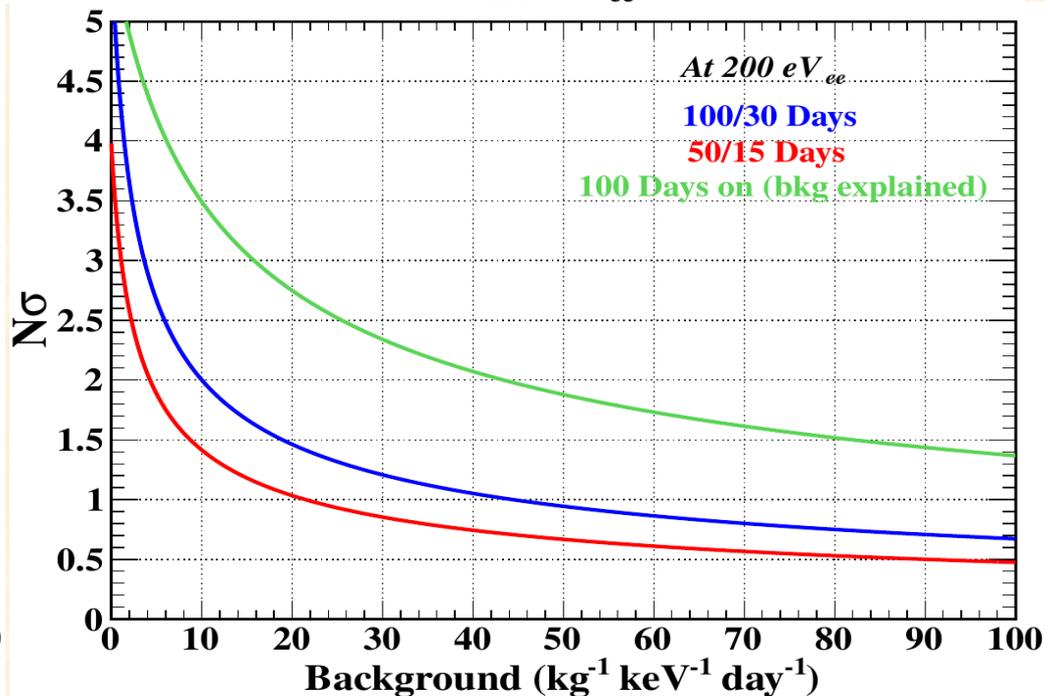
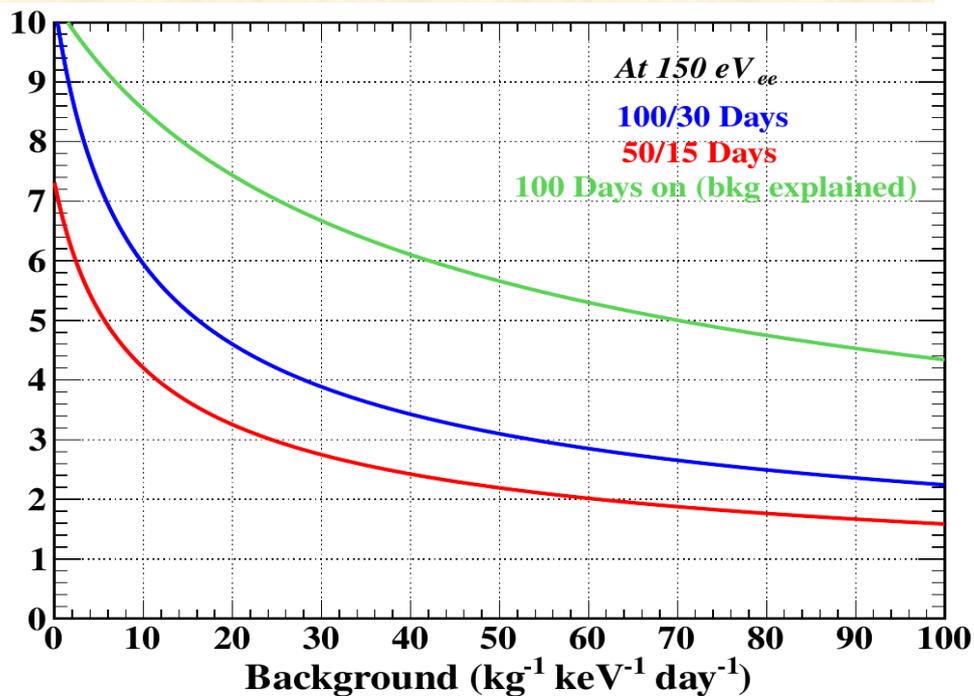
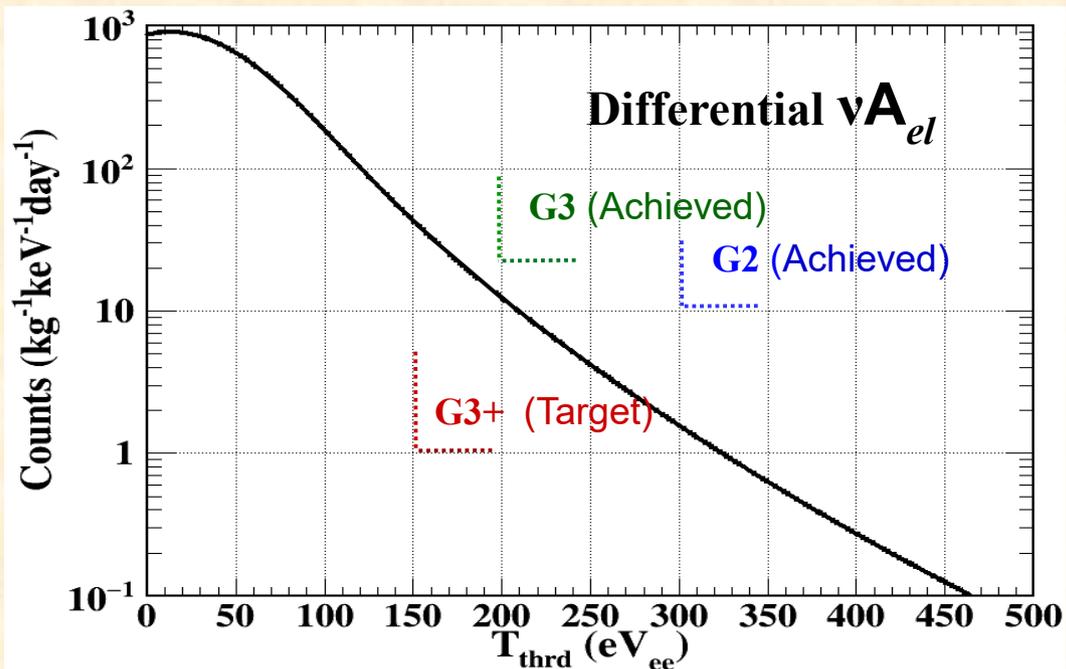




# Status to probe $\nu A_{el}$



$$\frac{d\sigma_{\nu A_{el}}}{dq^2}(q^2, E_\nu) = \frac{1}{2} \left[ \frac{G_F^2}{4\pi} \right] \left[ 1 - \frac{q^2}{4E_\nu^2} \right] \times [\epsilon Z F_Z(q^2) - N F_N(q^2)]^2$$



# THU Ge-activities

Litao Yang (THU)

On behalf of CDEX

# ● The manufacture of HPGe



Mechanical Preparation



Lithium Diffusion



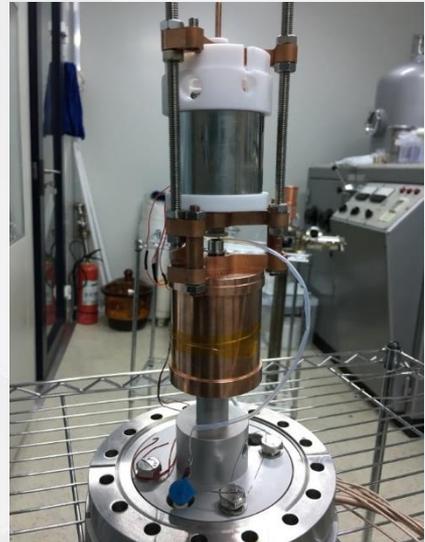
Wet Lab



Boron Ion Implant



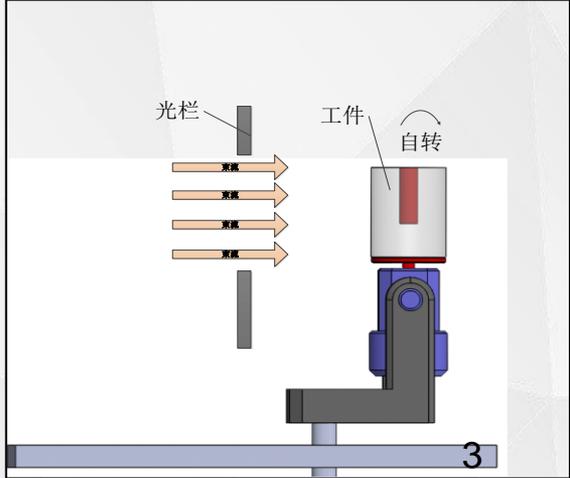
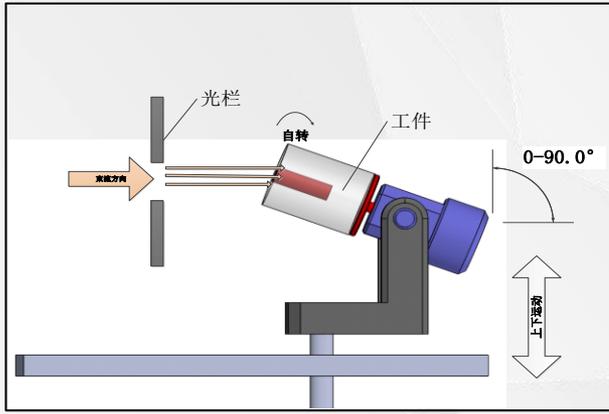
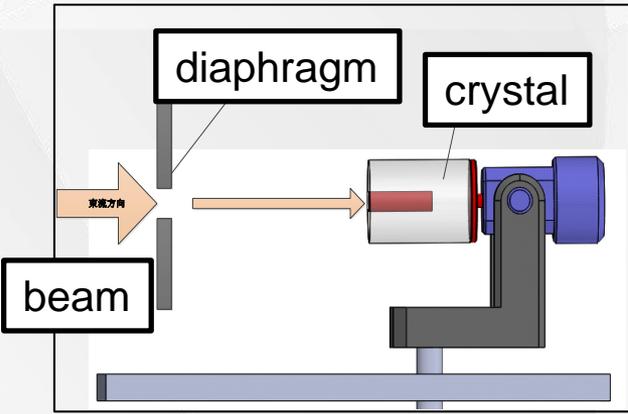
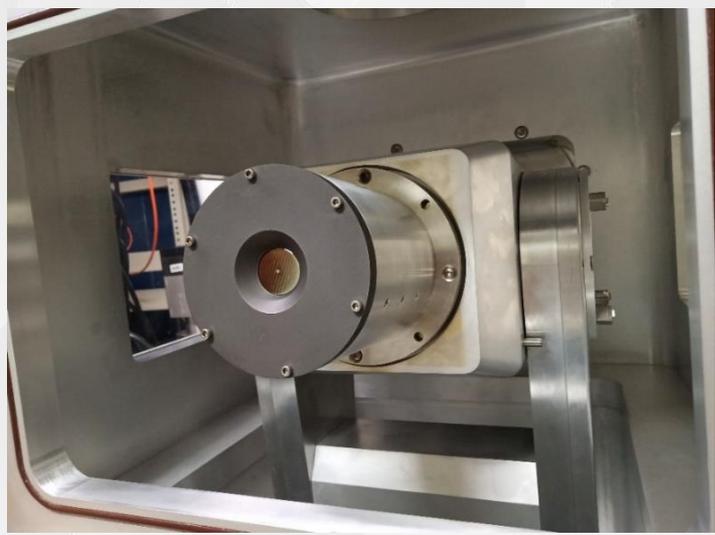
Surface Passivation



HPGe detector

# ● New Ion Implanter

- ✓ Specially designed for HPGe injection, Max. crystal size:  $\Phi 100\text{mm} \times 90\text{mm}$
- ✓ Injection elements: B, P, Ar



# ● Laboratory and equipment upgrades



Glove box @ CJPL-I



Fume hood



Water Purifier



Glove box @ THU

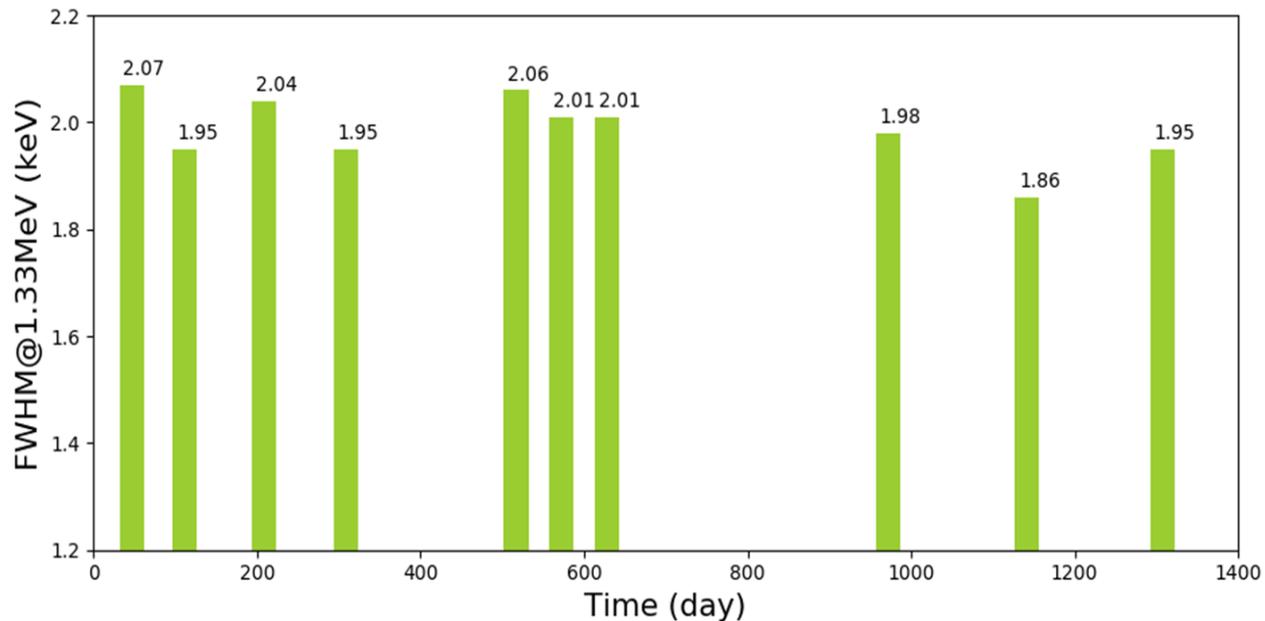
- ✓ First assembly test of the home-made HPGe detector in CJPL-I was completed;
- ✓ A small LN<sub>2</sub> tank was equipped in the glove box@THU, for the test of Bare HPGe in LN<sub>2</sub>;

# ● Long-term stability study

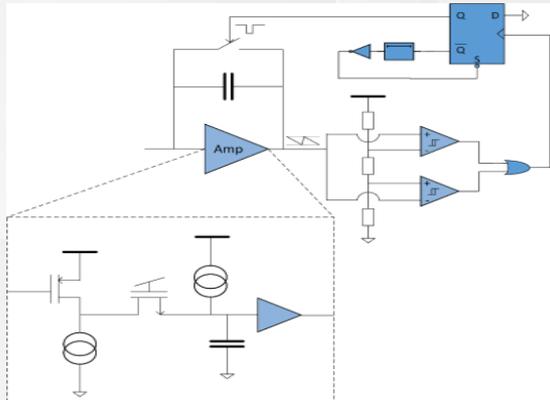
- ✓ Detector: 19#
  - ✓ PPCGe detector,  $\Phi 50\text{mm} \times 50\text{mm}$
  - ✓ Pre-amplifier: Pulse-reset
- ✓ Latest measure results(2018/10/24):
  - ✓ Leakage current: 16pA
  - ✓ FWHM: 0.72keV@122keV, 1.95keV@1.33MeV



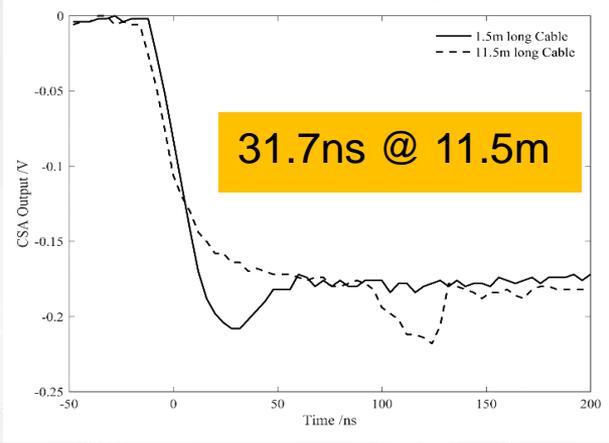
Stored at room temperature, cooled down for test, good performance keeping, >1300 days



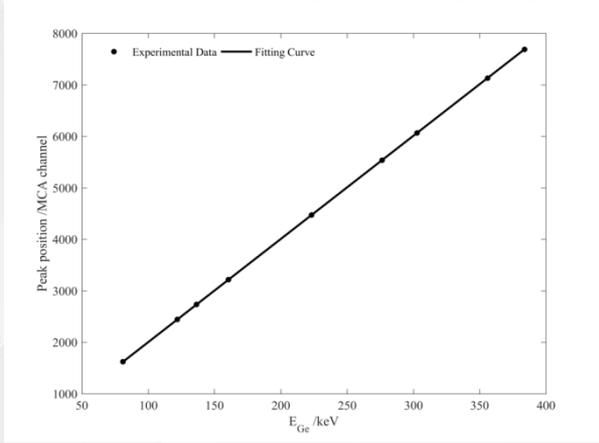
# ● CMOS Preamplifier ASIC



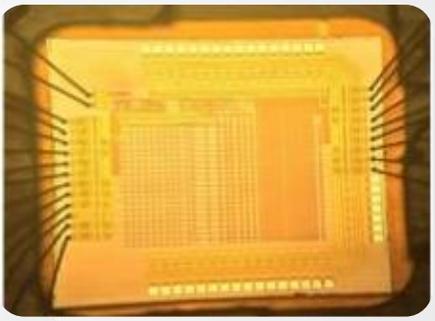
The schematic of the preamplifier with pulse reset



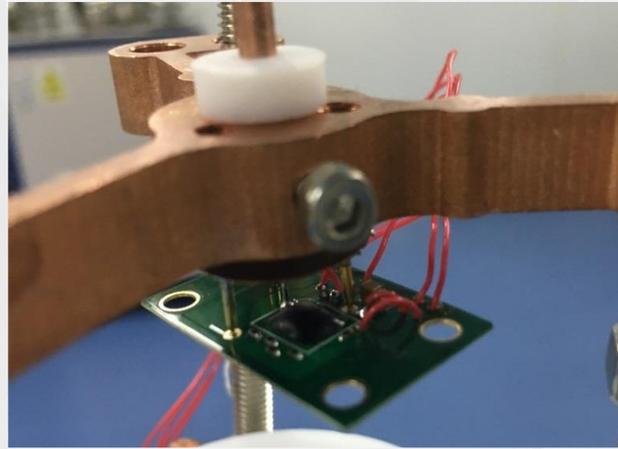
Drive capability > 10m



Linearity test: INL < 0.01%



Layout of ASIC preamplifier  
3mm x 3mm



The Readout PCB board

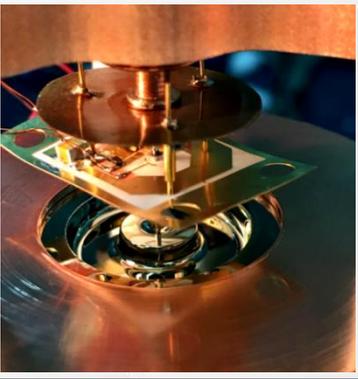
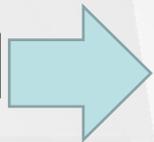
- PCB Material : Rogers 4850
- Tight control on dielectric constant and low loss, close to PTFE
- Utilizing same processing method as standard epoxy/glass (FR4)

# ● THU-1: ASIC + PPCGe

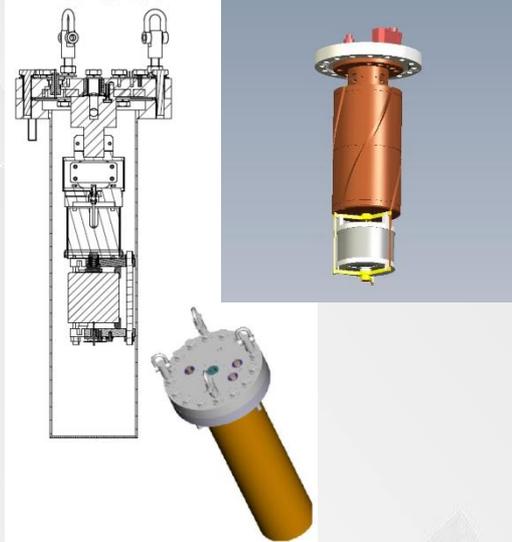
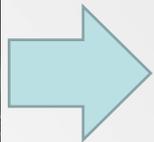
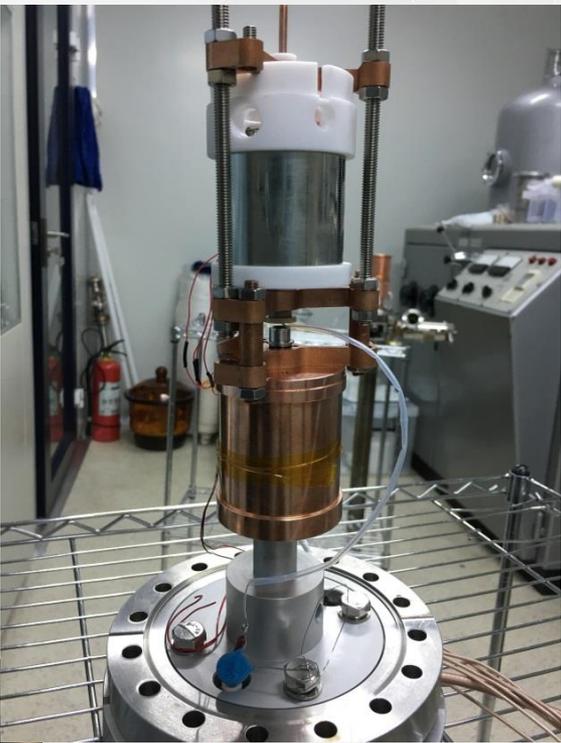
- First 500g home-made PPCGe+ASIC finished testing, energy resolution and energy threshold compared with commercial one.



PPC:  $\phi 50\text{mm} \times 50\text{mm}$

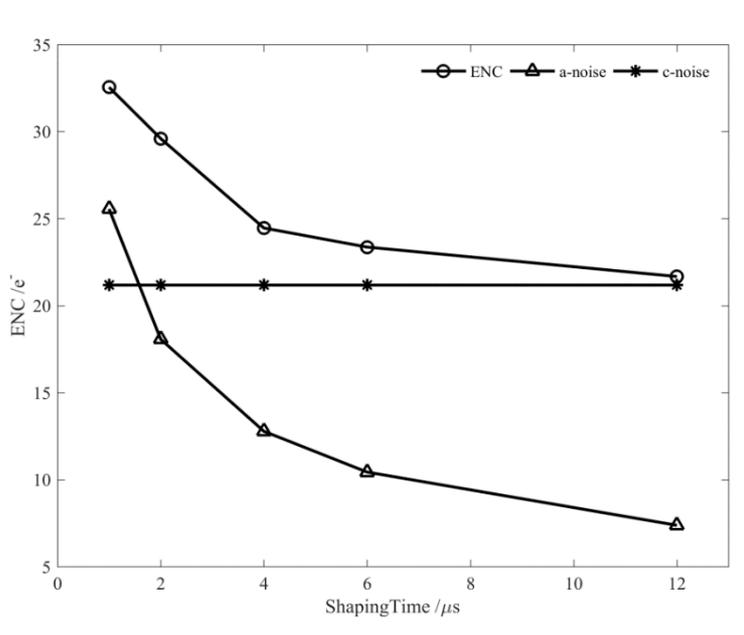


Low noise & low bkg ASIC electronics

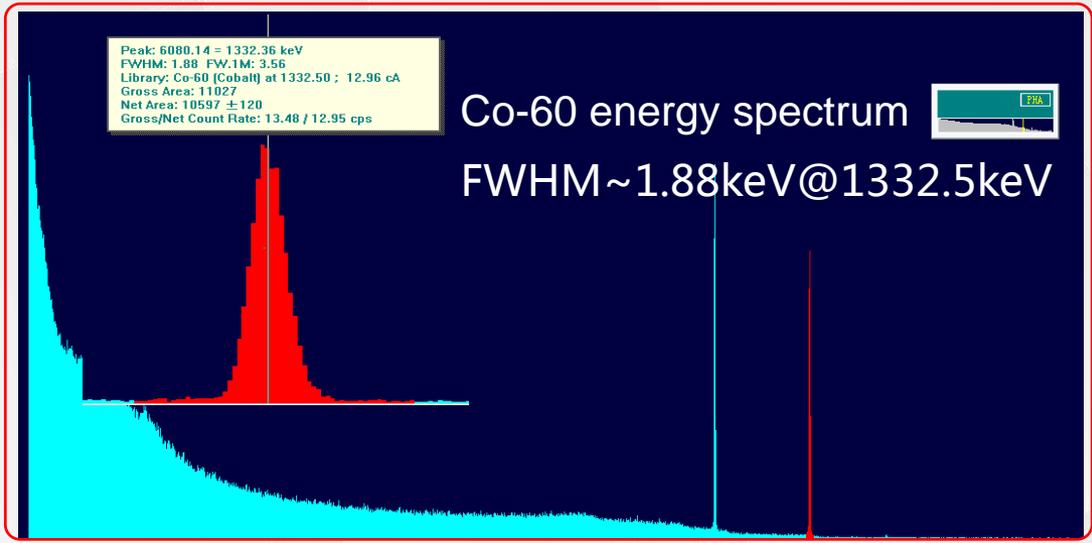
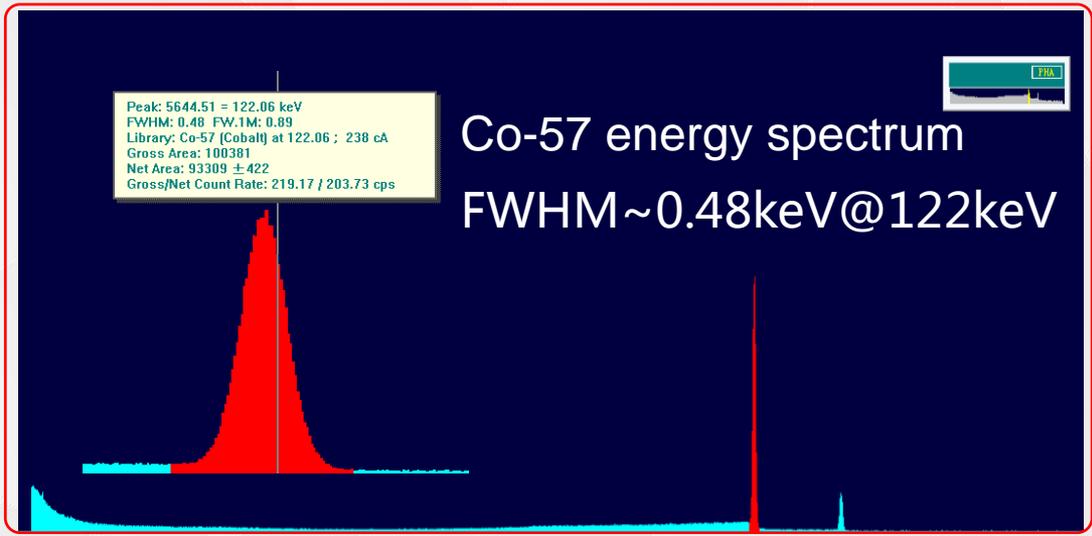


# ● THU-1 HPGe Detector Performance @ THU

Noise components analysis:  
the b-noise is ultra low!



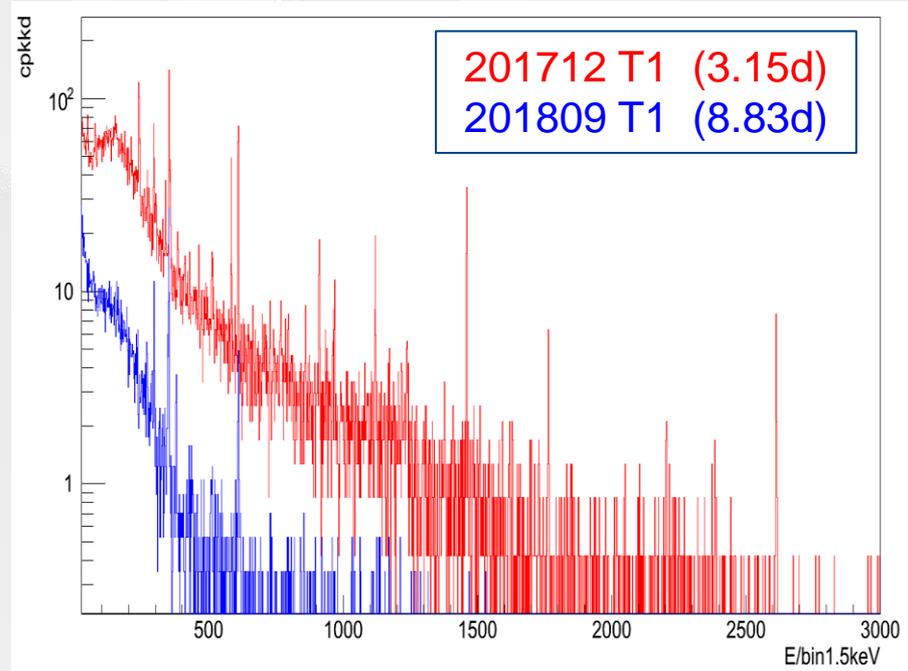
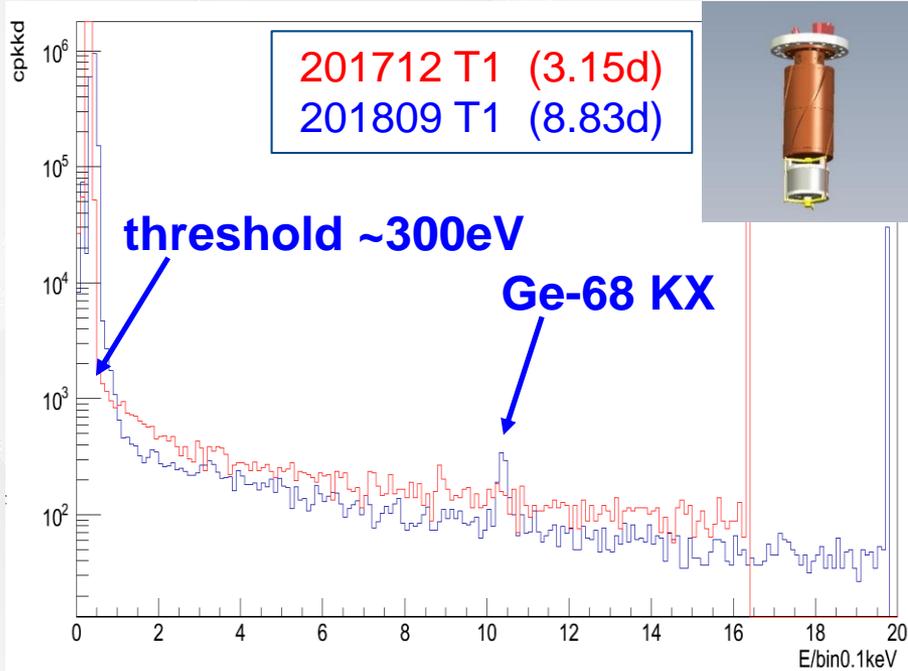
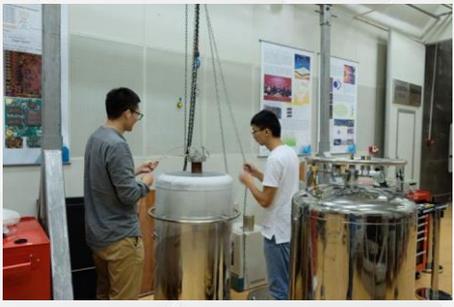
**ENC~21.7e**  
**182eV FWHM → 152eV FWHM**



# ● THU-1 HPGe Detector Performance @ CJPL

Reset Period ~ 5.7s, Leakage Current ~ 0.043pA.

- ✓ Commercial Ge crystal;
- ✓ Structure machining;
- ✓ Li-drift and B-implanted;
- ✓ Home-made ULB PreAmp;
- ✓ Underground EF-Cu;
- ✓ Underground assemble;
- ✓ Underground testing...

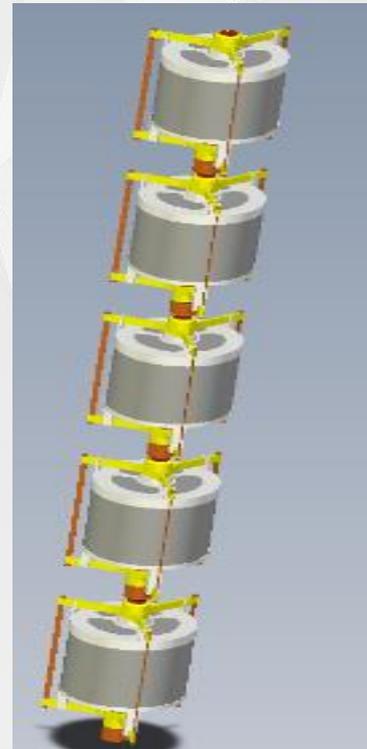
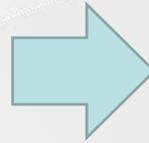


Background spectrum  
@low energy region (0~20keV)

Background spectrum  
@high energy region (0~3000keV)

## ● Bare HPGe detectors in LN<sub>2</sub>

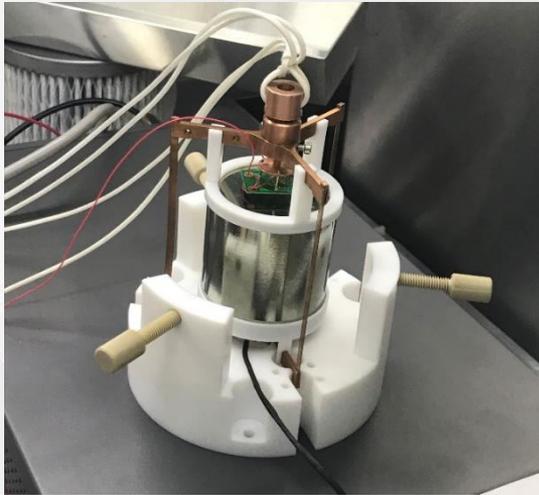
- Vacuum chamber, structure materials, not conducive to further reduce the radioactive background;
- ASIC-based preamplifiers can work well in liquid nitrogen;
- ✓ **Develop bare HPGe detectors immersed into LN<sub>2</sub>!**



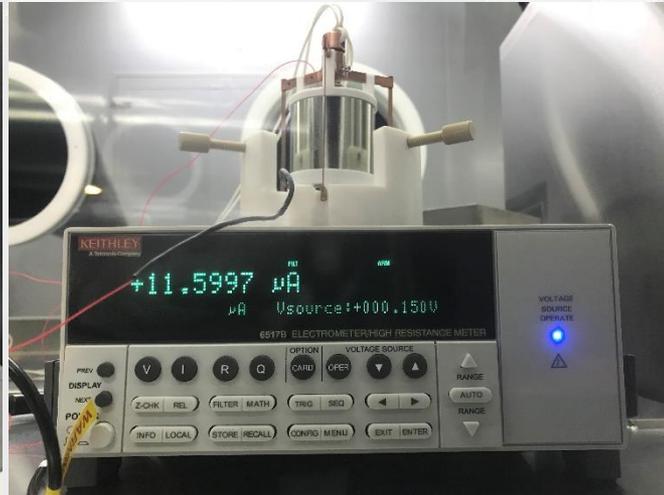
CDEX-10 detector string layout

# ● Bare HPGe detectors in LN<sub>2</sub>

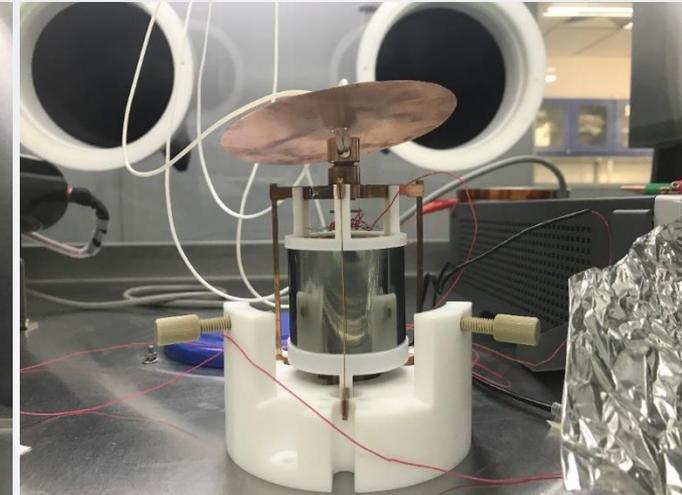
- The leakage current was measured by an electrometer, which also supplied the high voltage at the same time;
- In order to shield infrared radiation, we used a similar design from Gerda. **A copper sheet** is placed above the crystal holder to **block infrared radiation** from the LN<sub>2</sub> tank, lower the leakage current.



Detector structure of test

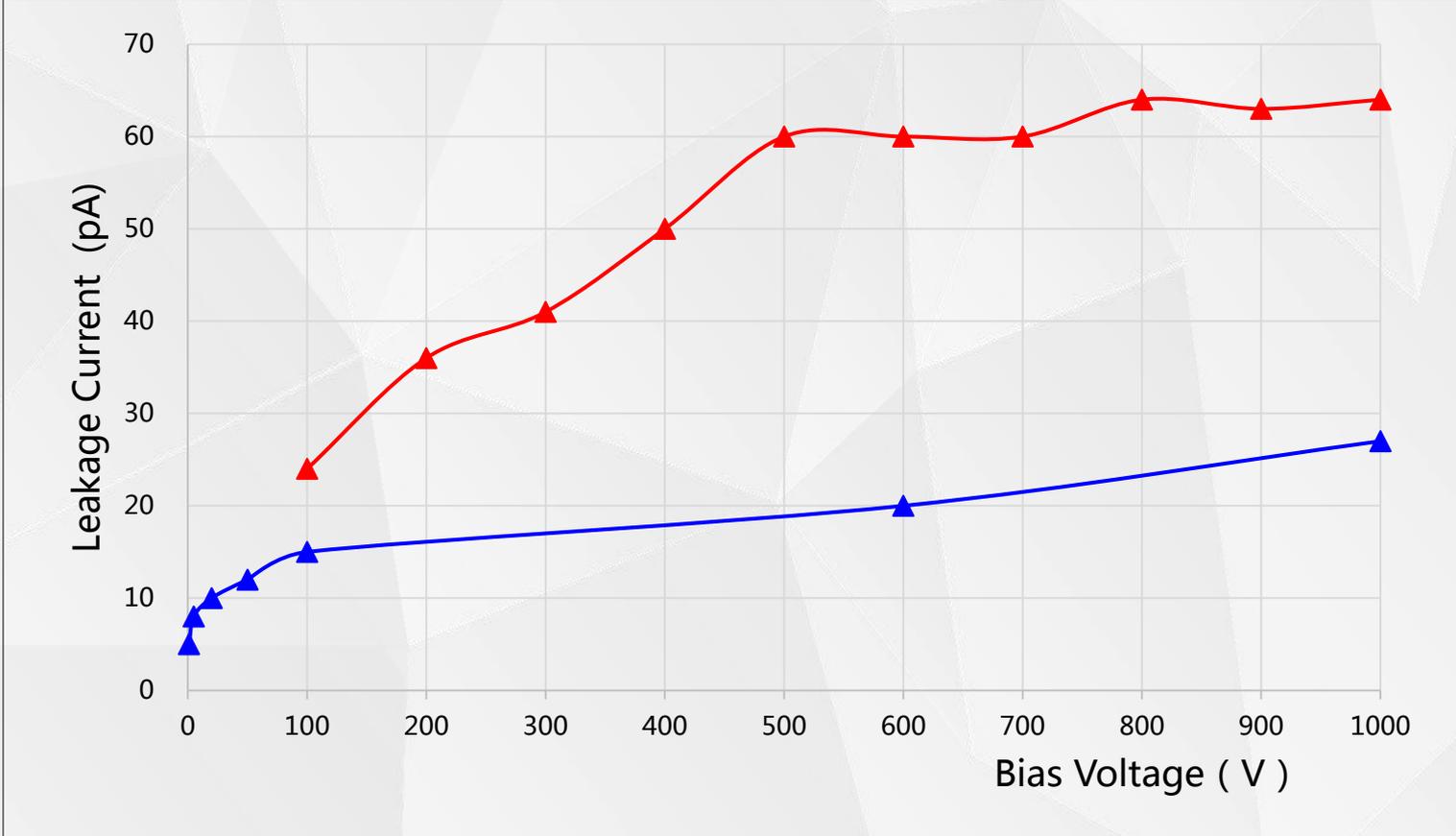


Electrometer  
/high resistance meter



Bare HPGe detectors  
(with infrared radiation shielding)

# ● Bare HPGe detectors in LN<sub>2</sub>

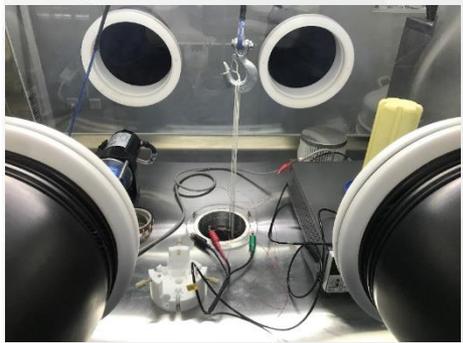


The relationship between Leakage Current & Bias Voltage

Red: for 3 hours, without infrared radiation shielding

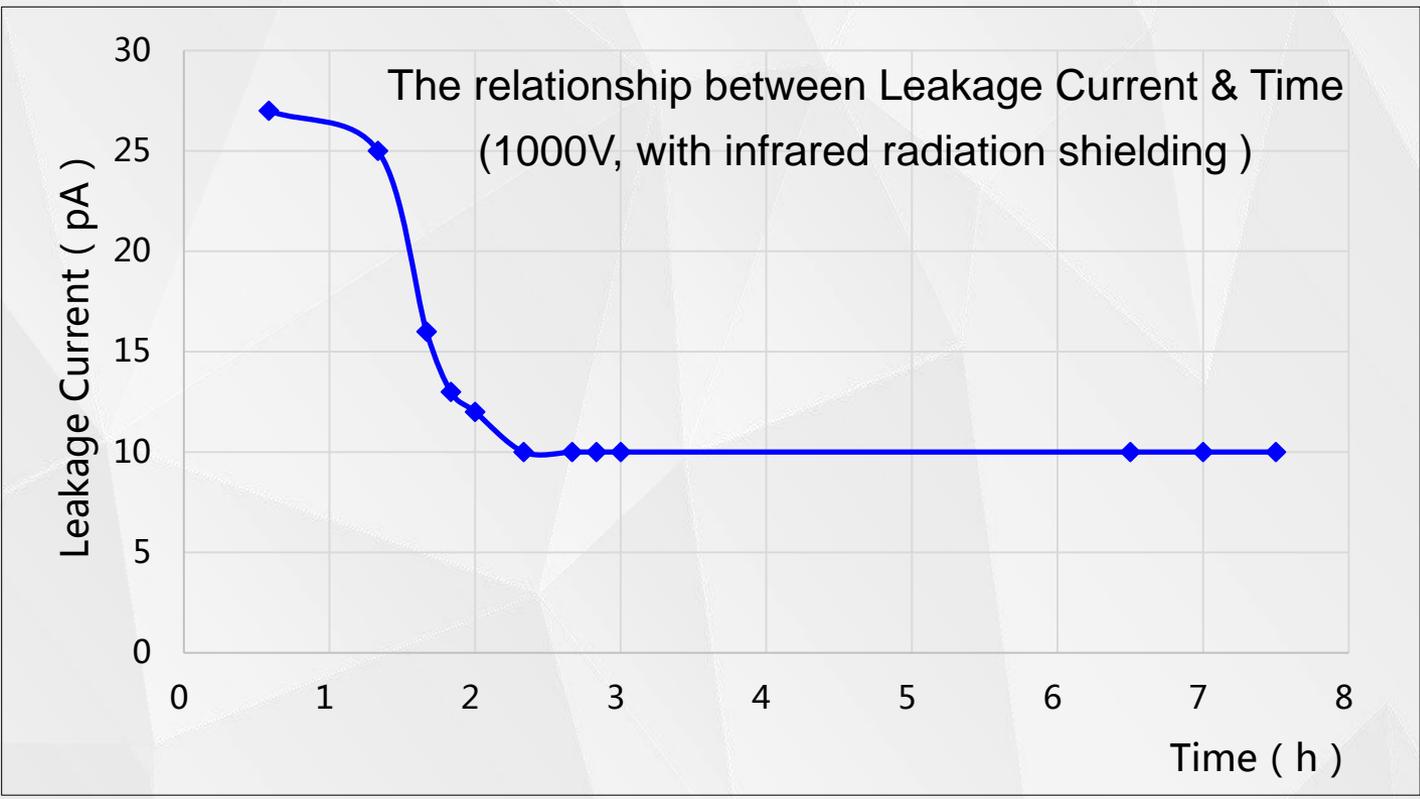
Blue: for 0.5 hours, with infrared radiation shielding

# ● Bare HPGe detectors in LN<sub>2</sub>



Bare HPGe in LN<sub>2</sub>

PPC:  $\phi 50\text{mm} \times 50\text{mm}$   
Depleted voltage:  $\sim 800\text{V}$

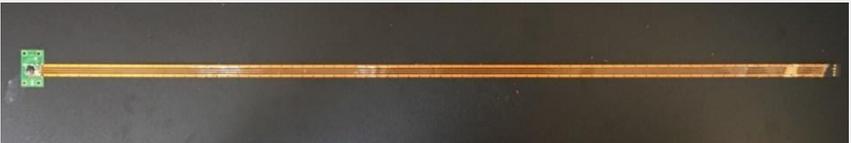


Immerse the detector into liquid nitrogen for about 8 hours, we got a stable leakage current  $\sim 10$  pA for 1000V bias voltage.

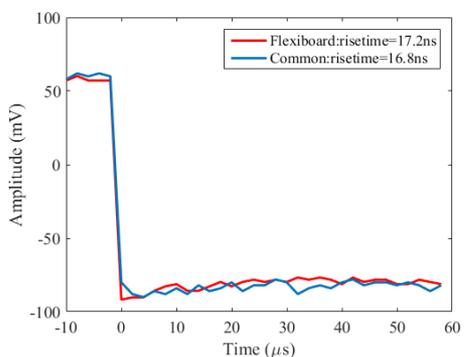
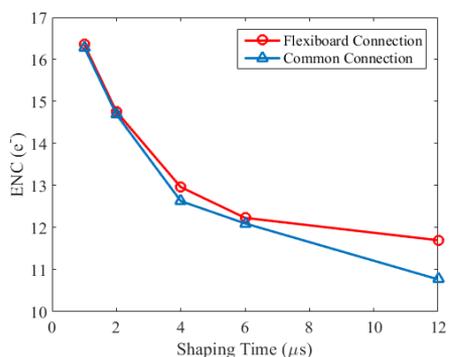
# Low background VFE

## Flexible Cable

- lower background than coaxial cable
- now: Kapton
- next plan: PTFE (more pure, longer)



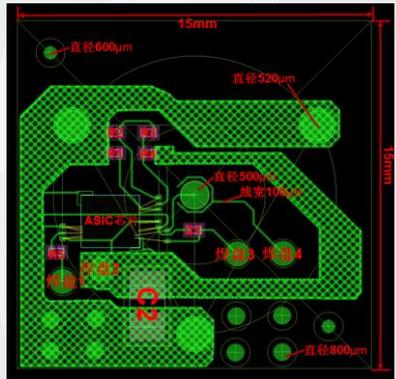
The ASIC board with 60cm long Flexible cable



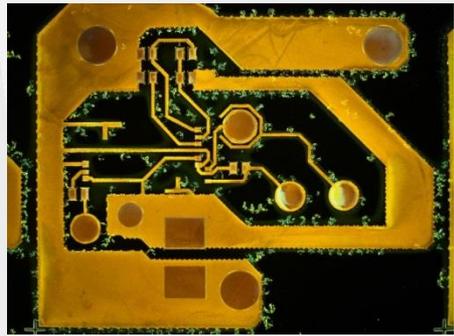
The performances of ASIC Preamplifier with Flexible cable are not degraded.  
-noise --risetime

## Si substrate

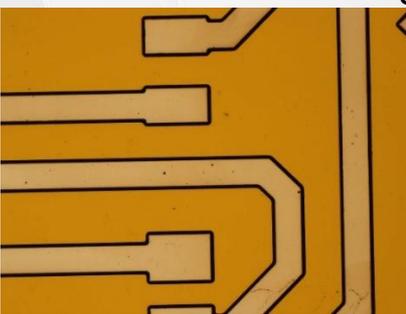
- The lowest background circuit substrate material
- Micromachining → low mass
- The first version of silicon substrate processing is currently completed



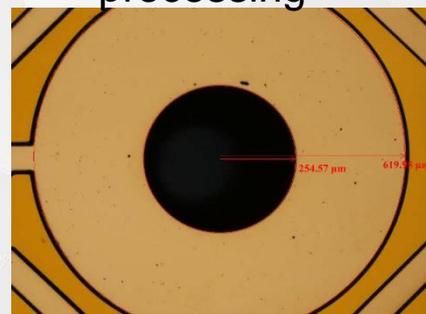
Silicon substrate design



Silicon substrate processing

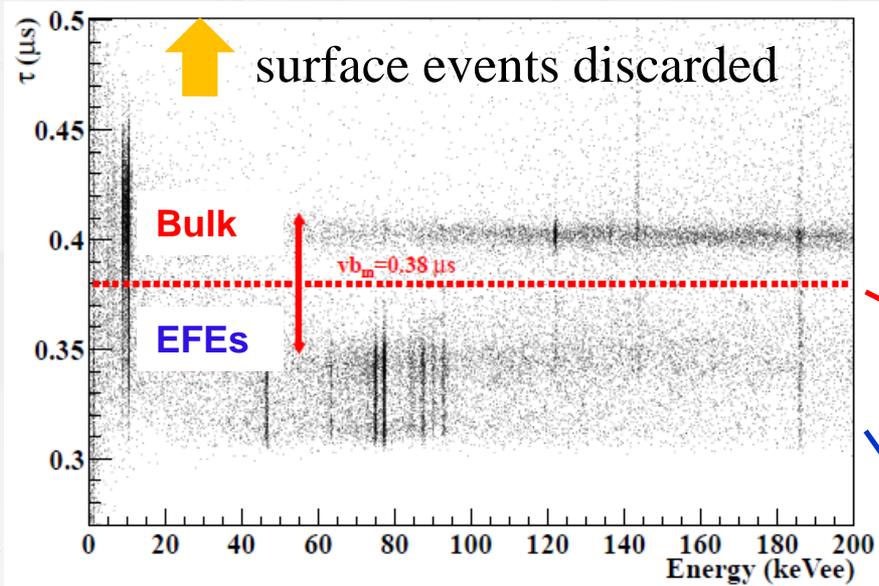


Wiring (After plating)

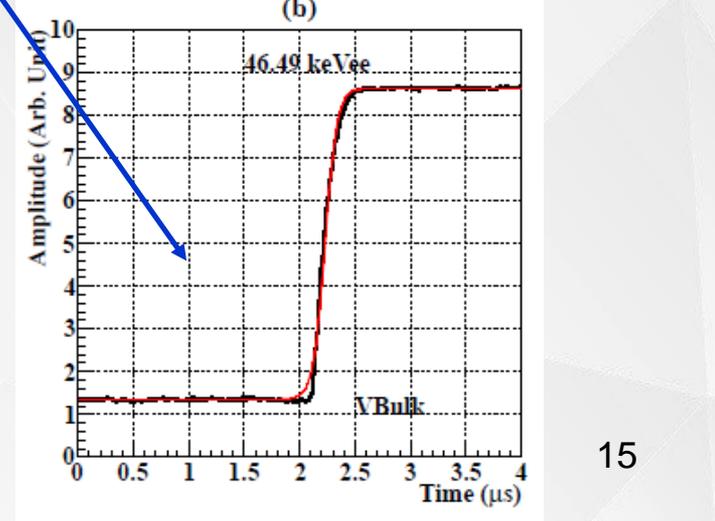
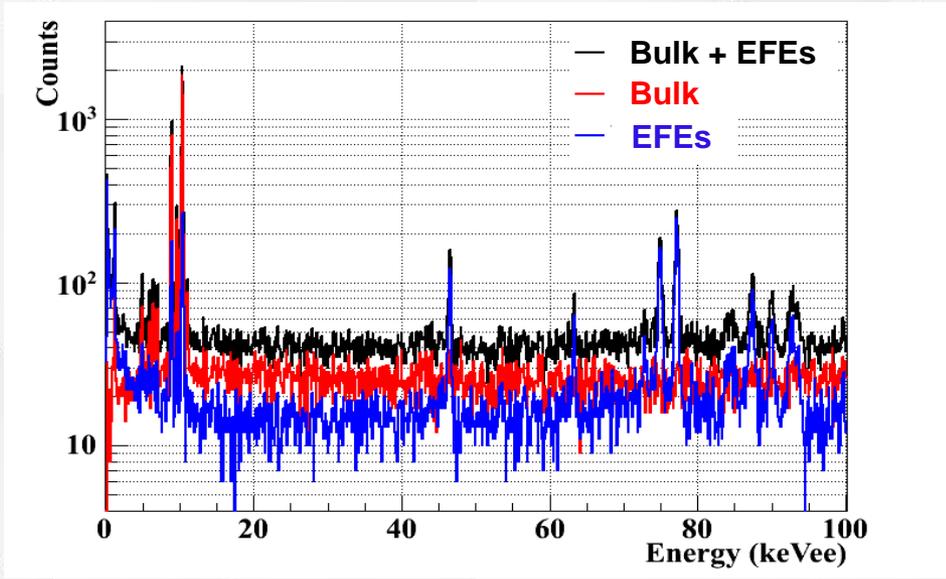
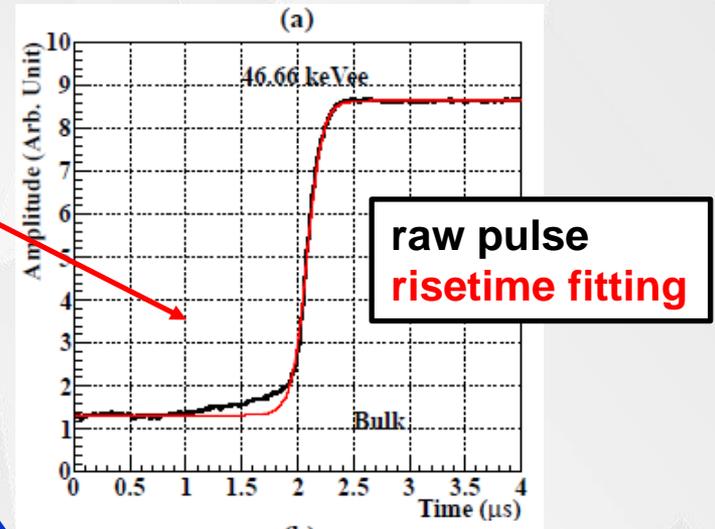


Central through-hole (After plating)

# EFEs in CDEX-1B/10 background data



- ❖ Measured pulses:
  - ✓ Top: Bulk event
  - ✓ Bottom: EFE



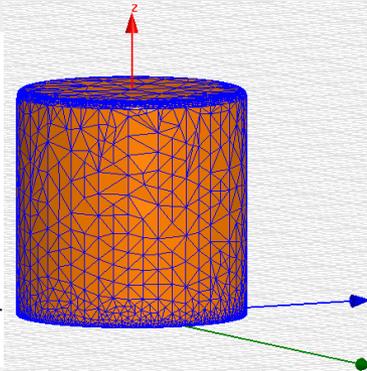
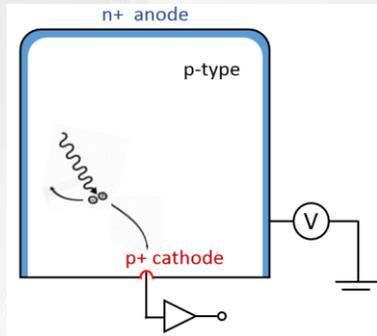
# ● Detector simulation

- **Pulses generated by**

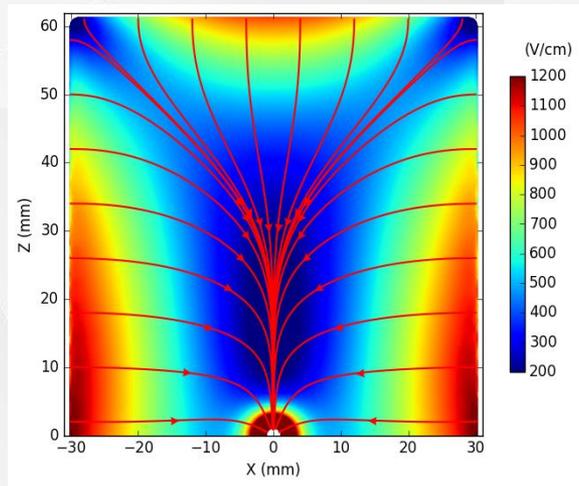
- ✓ Geant4: interaction & energy deposition;
- ✓ ICC package: Induced Charge/Current signal (Shockley-Ramo theorem);

- **P-type Point-Contact (PPCGe) detector:**

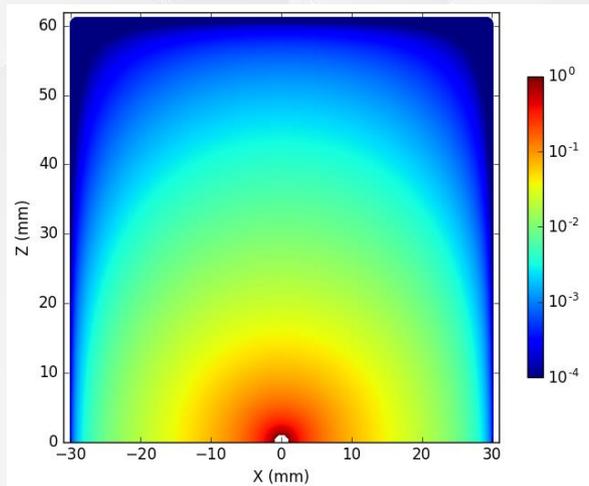
- ✓ Small point-like central contact
- ✓ Especially low capacitance ( $\sim 1\text{pF}$ ) gives superb energy resolution and low energy threshold



Finite element analysis of E-field (Maxwell)



**Electric field**



**Weighting potential**

### Impurity concentration:

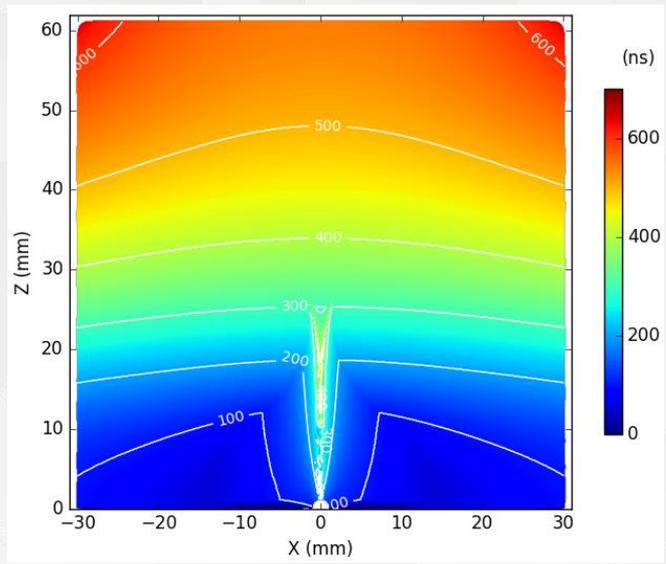
- ✓  $[-0.5, -0.8] \times 10^{10}\text{cm}^{-3}$
- ✓ no radial gradient

### Bias Voltage:

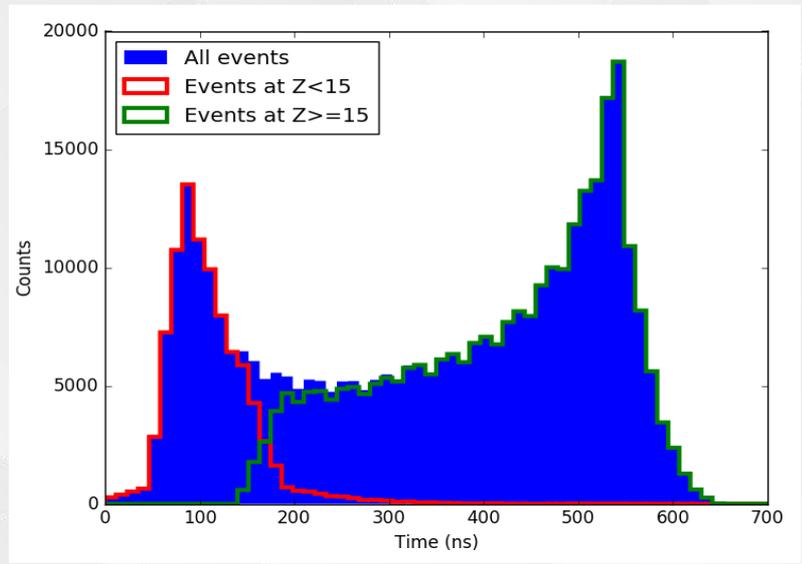
- ✓ + 3000V

# ● EFEs origin -- detector simulation

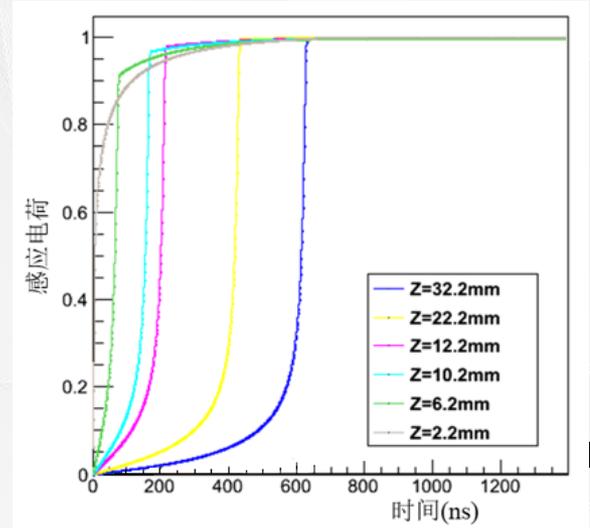
### Drift time contour



### Drift time distribution

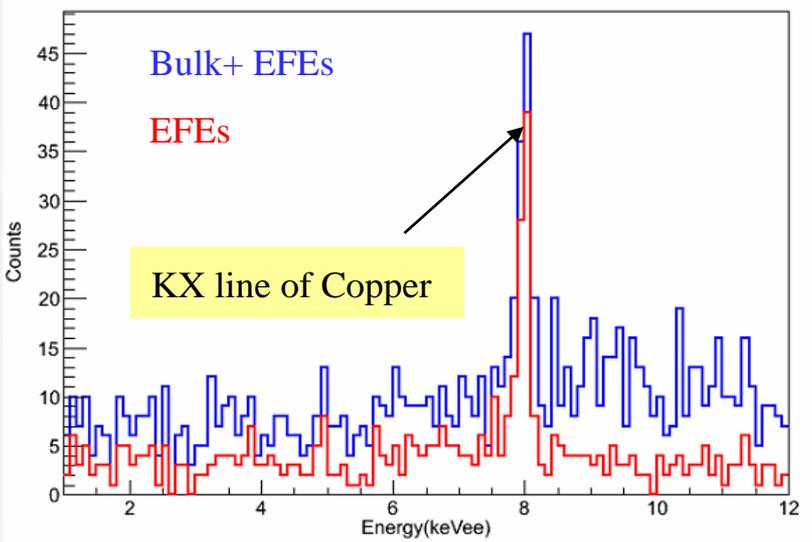


- The very-bulk events mainly arise from the bottom part of the PPC detector
- Very-bulk events discrimination can probably be used for background rejection

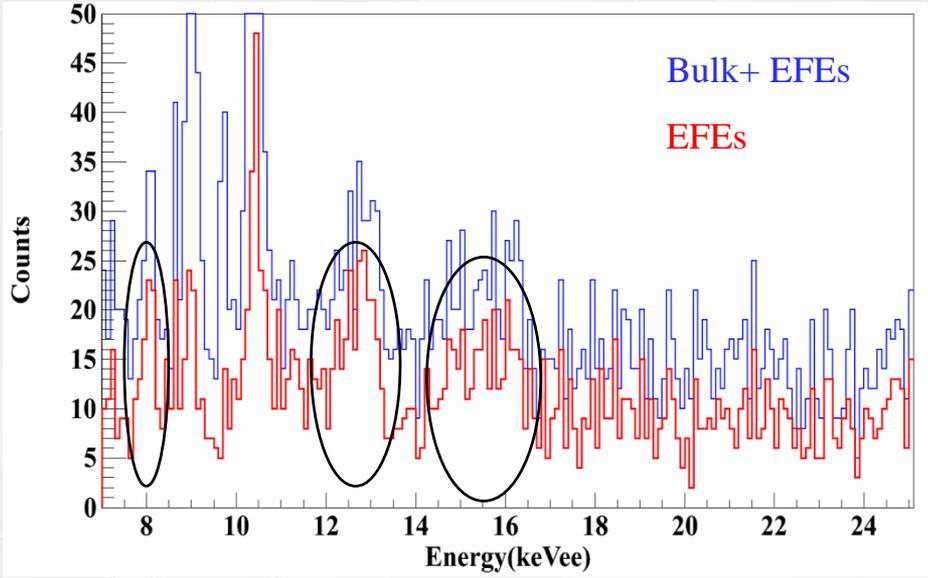


# EFEs origin -- Experimental verification

<sup>109</sup>Cd gamma source



Background spectrum



- ✓ 8 keV X-rays from Copper was observed in EFes spectrum of the <sup>109</sup>Cd samples;
- ✓ In the background spectrum, there are some clear peaks (12-16keV), which are dominated as EFes;
- ✓ Experimentally verified that the ultra-fast case comes from the end face of the point electrode where there is no dead layer.

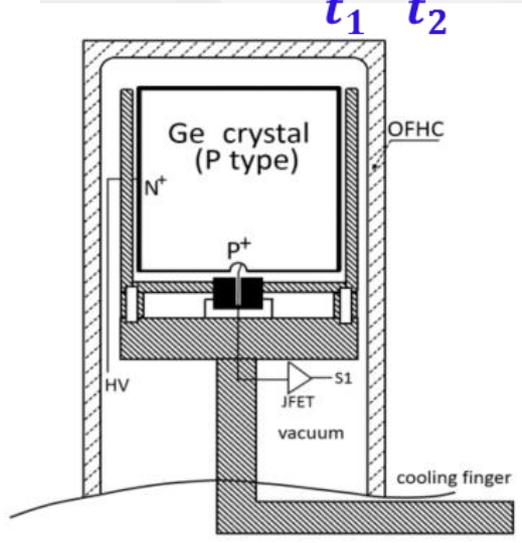
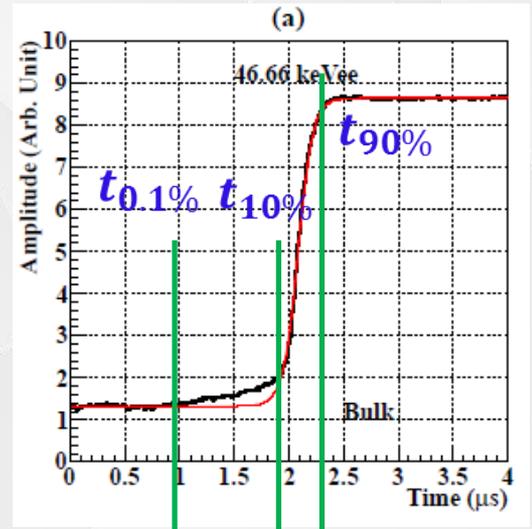
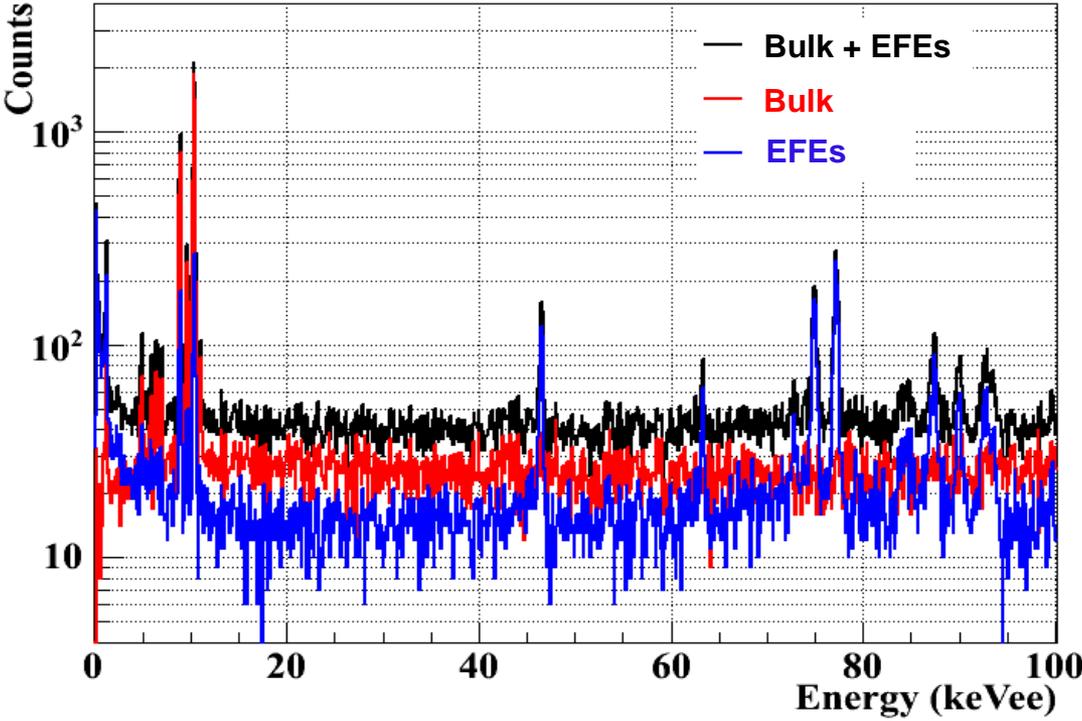
Nuclide	Type	Energy(keV)
Cu	L $\alpha$	8.04
Pb	L $\beta$	12.62
Bi	L $\beta$	13.01
Th	L $\alpha$	12.85
	L $\beta$	15.62
		16.20
Ra	L $\alpha$	12.34
		12.20
	L $\beta$	14.84
		15.24 <b>18</b>

# What we learned from EFEs studies? (1)

## (1) Suppress the background level

Define the drift time:  $t_1 = t_{10\%} - t_{0.1\%}$

- Drift time is related to the energy deposited location;
- Possibility of fiducial selection, remove as much as possible while retaining as much fiducial mass as possible.



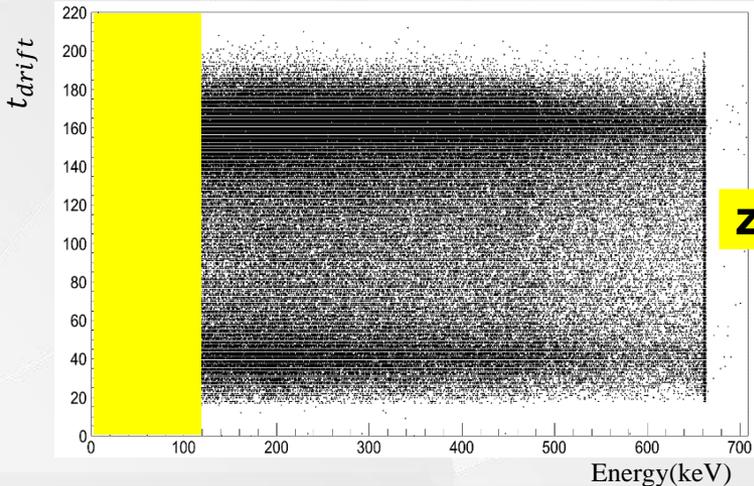
# What we learned from EFEs studies? (2)

## (2) Improve energy resolution

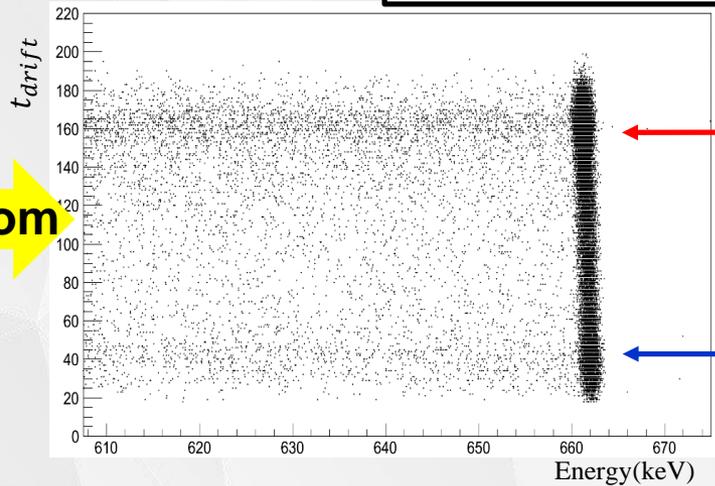
- ✓ Distribution of  $t_{drift}-E$  provides information on  $\tau$  of the carriers;
- ✓ Correct the energy to improve the energy resolution;

$$Q_{trapping} = Q_0 \cdot \left[ 1 - \exp\left(-\frac{t_{drift}}{\tau}\right) \right]$$

**Cs-137 calibration data**

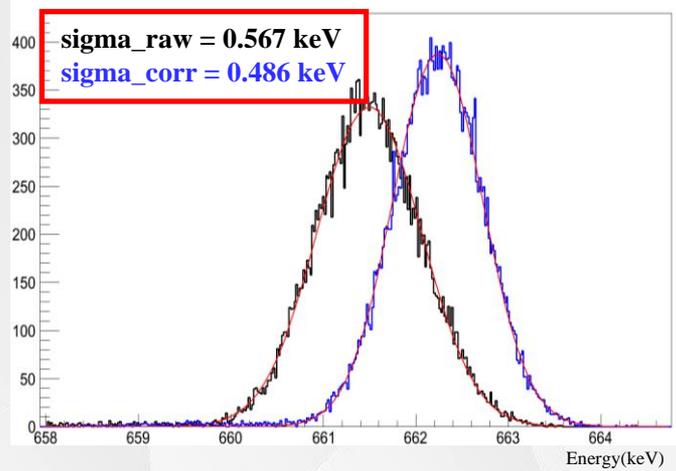
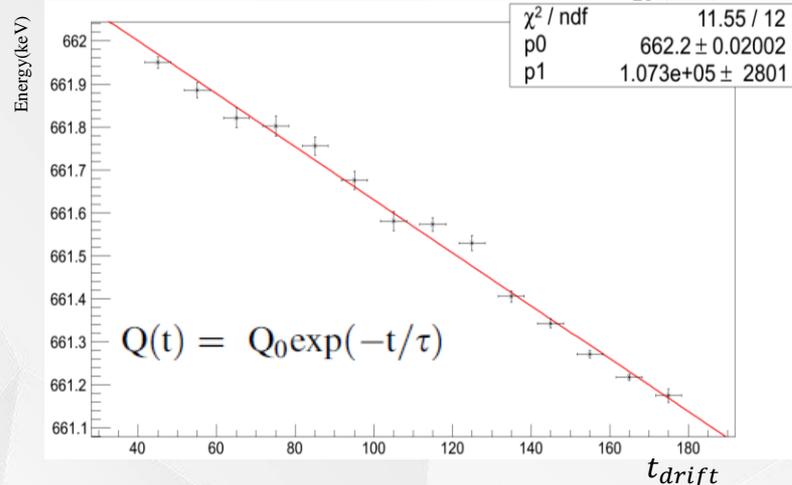


**zoom**



**Bulk**

**EFEs**

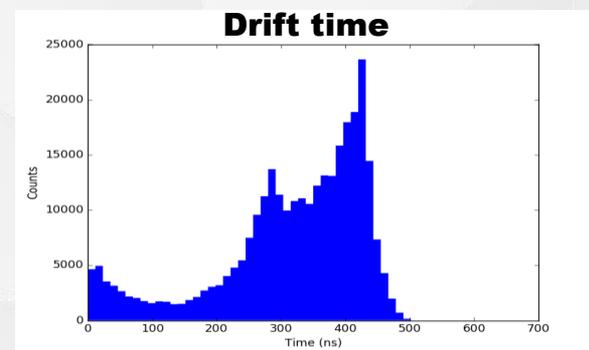
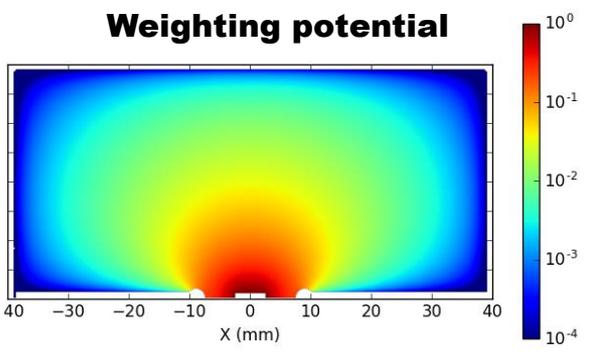
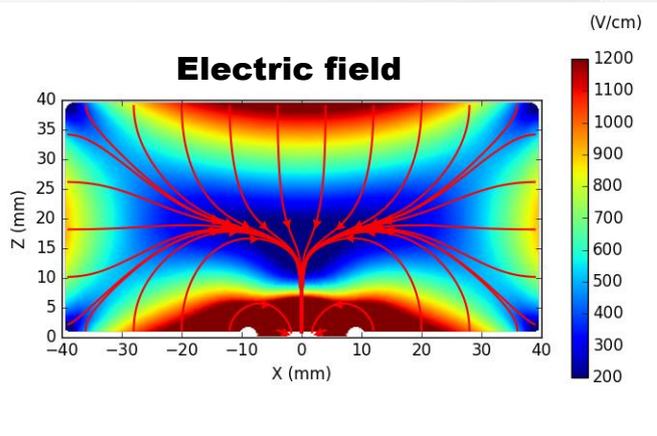
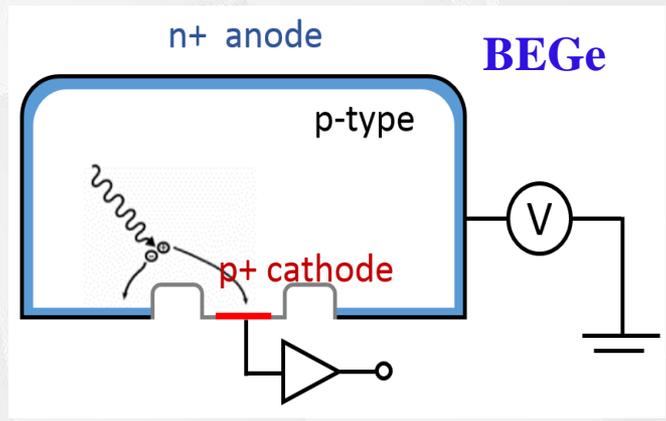


# What we learned from EEs studies? (3)

- ❖ n+ anode covers the front, lateral and most of the bottom part, which helps to shield the background events;
- ❖ Optimization of the ratio of diameter to height, short drift time length and uniform distribution results in better energy resolution.

## • BEGe detectors with thick window:

- ✓ a planar p-type detector with a relatively small cathode on the bottom side
- ✓ relatively small capacitance (a few pF)
- ✓ smaller EEs region near the p+ contact



# ● Conclusion

- ✓ Laboratory and equipment upgrades, the entire assembly processes of HPGe were proceeded well and were well-established;
- ✓ First 500g home-made PPCGe+ASIC with threshold of  $\sim 300$  eV and visible  $^{68}\text{Ge}$  X-ray obtained has been achieved;
- ✓ Bare Ge in  $\text{LN}_2$  with stable leakage current of  $\sim 10$  pA under 1K Voltage applied is accomplished;
- ✓ R&D on low background VFE, Si substrate and flexible cables are intensively studied;
- ✓ The study of EFEs can help to better understand the background origins, improve the energy resolution at high energy ranges, optimize detector design on charge collection & bkg reduction.